

## SM2256 Flash F/W & ISP Release Information

### Introduction

This purpose of this document is to provide release information on the SM2256 F/W and ISP release information

### Fix Coverage

- Stands for the “**new fix**” or “**new support**” in the category
- Stands for the “**no-update**” in the category

■ <b>Tester FW</b>	■ <b>Controller ISP</b>
<ul style="list-style-type: none"> <li>□ <b>Yield Issue</b></li> <li>■ <b>Flash Issue</b> <ul style="list-style-type: none"> <li>□ SLC Flash               <ul style="list-style-type: none"> <li>□ Samsung Flash</li> <li>□ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>□ Hynix Flash</li> <li>□ Others</li> </ul> </li> <li>□ MLC Flash               <ul style="list-style-type: none"> <li>□ Samsung Flash</li> <li>□ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>□ Hynix Flash</li> </ul> </li> <li>■ <b>TLC Flash</b> <ul style="list-style-type: none"> <li>■ Samsung Flash</li> <li>■ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>■ Hynix Flash</li> <li>□ Others</li> </ul> </li> </ul> </li> <li>□ <b>Compatibility issue</b></li> <li>□ <b>Tester Bug Fix</b></li> <li>■ <b>AP Bug Fix &amp; New Function</b></li> <li>■ <b>Feature Enhance</b></li> </ul>	<ul style="list-style-type: none"> <li>■ <b>Yield Issue</b></li> <li>■ <b>Flash Issue</b> <ul style="list-style-type: none"> <li>□ SLC Flash               <ul style="list-style-type: none"> <li>□ Samsung Flash</li> <li>□ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>□ Hynix Flash</li> <li>□ Others</li> </ul> </li> <li>□ MLC Flash               <ul style="list-style-type: none"> <li>□ Samsung Flash</li> <li>□ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>□ Hynix Flash</li> </ul> </li> <li>■ <b>TLC Flash</b> <ul style="list-style-type: none"> <li>■ Samsung Flash</li> <li>■ Toshiba/Sandisk Flash</li> <li>□ Intel/Micron Flash</li> <li>■ Hynix Flash</li> <li>□ Others</li> </ul> </li> </ul> </li> <li>□ <b>Compatibility issue</b></li> <li>■ <b>ISP Bug Fix</b></li> <li>□ <b>Feature Enhance</b></li> </ul>

Version	MP Tool Version	ISP Version	Note
O1230C	O1228A	O1230C	<ol style="list-style-type: none"> <li>1. Bug fixes of rarely hit issues, 4K alignment in Extra Read, Multiple-CH Read in spare read link, read runtime Info in Pretest, and DMC issue after COMRST.</li> <li>2. Enable feature of identifying specific CH/CE failure during drive initialization.</li> </ol>
O1217A	O1201A	O1217A	<ol style="list-style-type: none"> <li>3. Update timing parameters of DRAM to accommodate PCB marginality.</li> <li>4. Improvement of error recovery flow for SPOR and S4 test.</li> </ol>
O1126A	O1201A	O1126A	<ol style="list-style-type: none"> <li>1. Bug fix of incorrect FW handling of UECC in WPRO block</li> <li>2. Bug fix of FW hang up issue in SPOR test</li> <li>3. Improvement of Vth tracking handling for Hynix TLC (issue found in SMI power cycle test)</li> <li>4. Add training window check in drive initialization</li> </ol>
O1015A	O0910B	O1015A	<ol style="list-style-type: none"> <li>1. Support SanDisk 1znm TLC.</li> <li>2. Fixed Hynix 16nm TLC read retry issue.</li> <li>3. Fixed the issue of mapping table building for SPOR.</li> <li>4. Add one function to avoid link mismatch for SPOR.</li> </ol>
O0803B5	O0910B	O0803B5	<ol style="list-style-type: none"> <li>1. Fixed Microsoft Win10 setup FW hang up issue (FW cannot be activated after being slumber state).</li> <li>2. Fixed read retry table fail of Hynix 16nm TLC.</li> </ol>
O0803A	O0811A	O0803A	<ol style="list-style-type: none"> <li>1. Fix the issue of error map handling when doing unsafe power cycle.</li> <li>2. Fix the issue of changing die command before accessing flash.</li> <li>3. Fix the issue that SLC spare block is risky to run out.</li> <li>4. Add the mechanism to avoid read ECC fail of next time.</li> <li>5. Fix the issue of FW hang up when doing SPOR test.</li> </ol>

O0626A	O0624A	O0626A	<ol style="list-style-type: none"> <li>1. Fix of the issue that Slumber current is higher than Partial.</li> <li>2. Fix of the issue of download ISP for Hynix 16nm 128Gb TLC.</li> <li>3. Enable support of manufacturing burn-in test (RDT) for production.</li> <li>4. Fixes of SMART issues for erase count and temperature.</li> <li>5. Fix of EOB fail handling in rebuild link flow.</li> </ol>
O0521A	O0506A	O0521A	<ol style="list-style-type: none"> <li>1. Fixes of CDM and ATTO test FW hang up issues.</li> <li>2. Fixes of S4 and SPOR issues.</li> <li>3. Disable SSC function.</li> <li>4. Enable Flash support of Samsung 16nm 128Gb TLC.</li> </ol>
O0414C	O0212C	O414C	<ol style="list-style-type: none"> <li>1. Enable SSC (at SATA interface).</li> <li>2. Disable write UNC command.</li> <li>3. Introduce program fail handling.</li> <li>4. Bug fix of read retry flow on Samsung 19nm 128Gb TLC.</li> <li>5. Enable UART interrupt to dump error/event log when FW hang up.</li> </ol>
O0306	O0127C	O0226B	<ol style="list-style-type: none"> <li>1. Bug fixes of SPOR.</li> <li>2. Improvement of timeout issue of WHCK test.</li> <li>3. Enhancement on RAID function.</li> <li>4. Support of Samsung 19nm TLC, Toshiba A19nm TLC, and Hynix 16nm TLC.</li> <li>5. Note that when used with SM2256AB chip, it's not required to initialize SPI EEPROM (via MP tool setting).</li> </ol>
N1230A SLC Cache	N1128B	N1230A	<p>FW</p> <ol style="list-style-type: none"> <li>1. Add "initial RAID engine" function.</li> <li>2. Fixed a mistake in the function of checking ECC fail</li> <li>3. Modify "restore RAID parity flow" to fix power cycle issue when Map ECC fails.</li> <li>4. LDPC mode is modified to be initialized by MPTool.</li> </ol> <p>SW</p>

			<ol style="list-style-type: none"> <li>For Hynix 16nm TLC, ignore checking the second byte of Flash ID.</li> </ol>
N1128C	N1117D	N1128C	<ol style="list-style-type: none"> <li>Support Samsung 19nm K9ADG TLC</li> <li>Support Toshiba A19 TLC</li> <li>Support Hynix H27QFG 16nm TLC</li> <li>Package of NAND flash which is supported – # of CEs is equal to # of dies</li> </ol>

**Note:**

- F/W and ISP update is recommended.
- History # is denoted by “Version-Date” .

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